



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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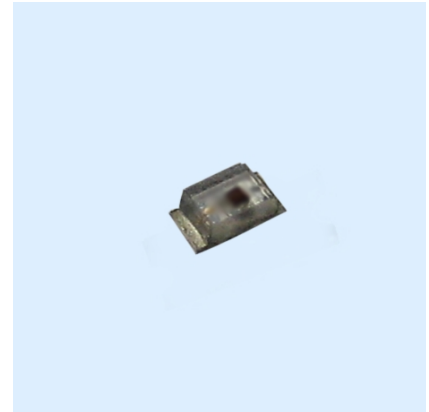
Technical Data Sheet Preliminary

0603 Package Chip LED (0.6mm Height leadframe)

19-013/R6SC-AQ2S1B/3T

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.



Descriptions

- The 19-013 SMD LED is much smaller than through hole type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

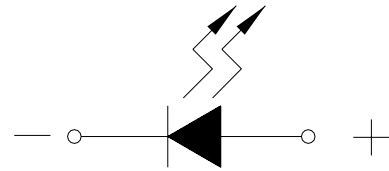
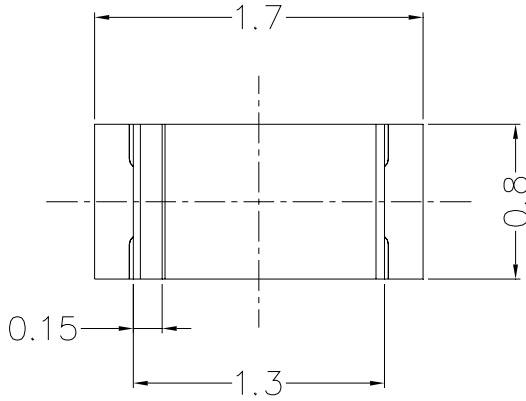
Applications

- outdoor displays
- flat backlighting(LCD,cellular phones,switches,displays)
- signal and symbol luminary
- marker light (e.g.steps,exit ways,etc.)

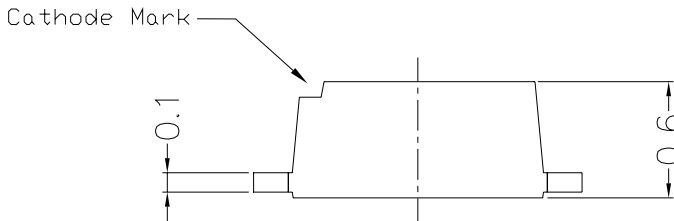
Device Selection Guide

Part No.	Chip		Resin Color
	Material	Emitted Color	
19-013/R6SC-AQ2S1B/3T	AlGaInP	Brilliant Red	Water Clear

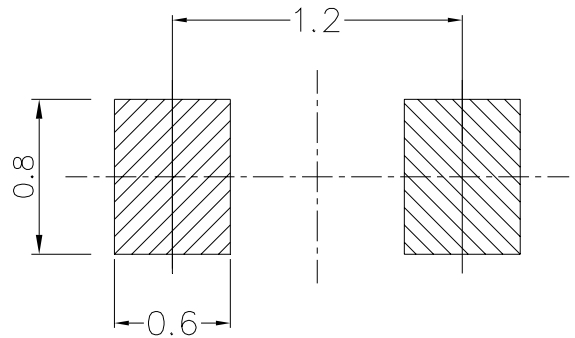
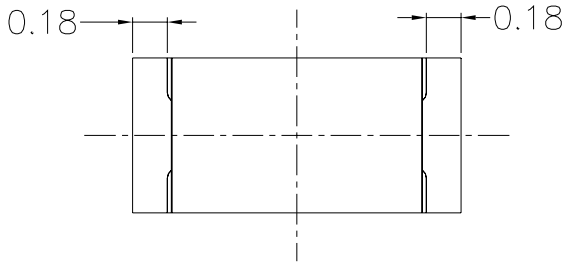
**Package Outline Dimensions**



Polarity



Recommended solder pad



**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Unit = mm

**Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Unit
Reverse Voltage	V <sub>R</sub>	12	V
Forward Current	I <sub>F</sub>	50	mA
Peak Forward Current (Duty 1/10 @1KHz)	I <sub>FP</sub>	100	mA
Power Dissipation	P <sub>d</sub>	120	mW
Electrostatic Discharge(HBM)	ESD	2000	V
Operating Temperature	T <sub>opr</sub>	-40 ~ +100	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +100	°C
Soldering Temperature	T <sub>sol</sub>	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

**Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	I <sub>v</sub>	90	-----	225	mcd	I <sub>F</sub> =20mA
Viewing Angle	2θ 1/2	-----	140	-----	deg	
Peak Wavelength	λ <sub>p</sub>	-----	632	-----	nm	
Dominant Wavelength	λ <sub>d</sub>	617.5	-----	633.5	nm	
Spectrum Radiation Bandwidth	Δλ	-----	20	-----	nm	
Forward Voltage	V <sub>F</sub>	1.75	-----	2.35	V	
Reverse Current	I <sub>R</sub>	-----	-----	10	μA	V <sub>R</sub> =12V

**Notes:**

- 1.Tolerance of Luminous Intensity ±11%**
- 2.Tolerance of Dominant Wavelength ±1nm**
- 3.Tolerance of Forward Voltage ±0.1V**

**Bin Range Of Luminous Intensity**

Bin	Min	Max	Unit	Condition
Q2	90	112	mcd	IF=20mA
R1	112	140		
R2	140	180		
S1	180	225		

**Bin Range Of Dom. Wavelength**

Bin	Min	Max	Unit	Condition
E4	617.5	621.5	nm	IF=20mA
E5	621.5	625.5		
E6	625.5	629.5		
E7	629.5	633.5		

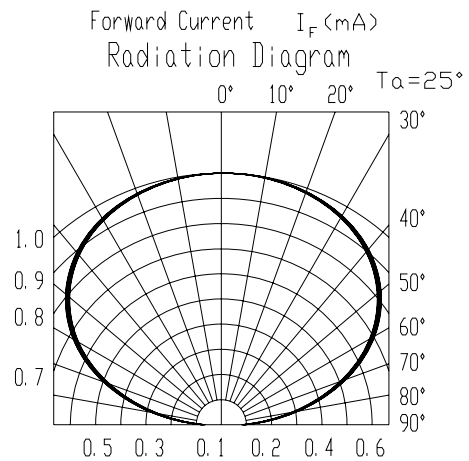
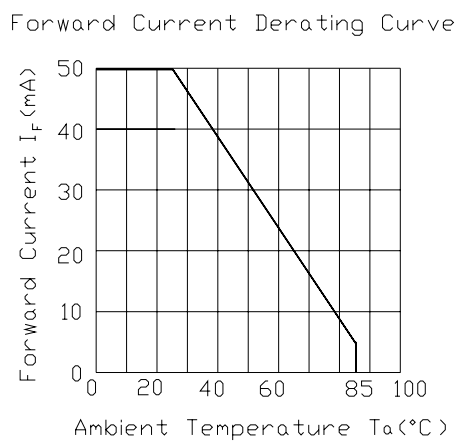
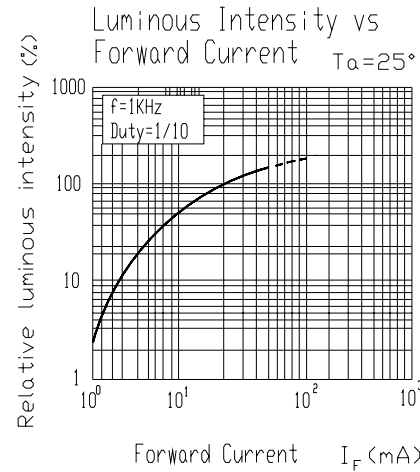
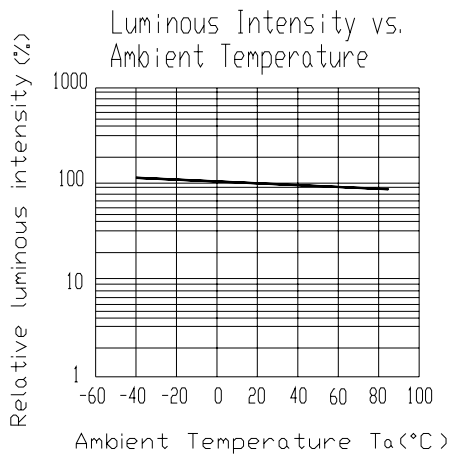
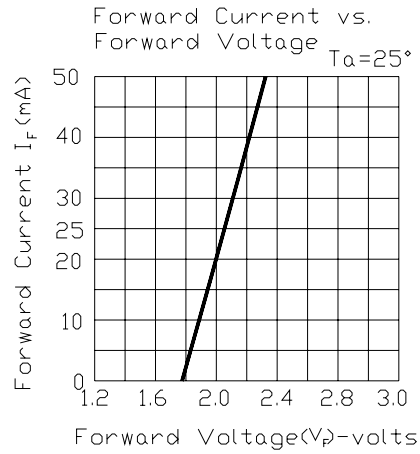
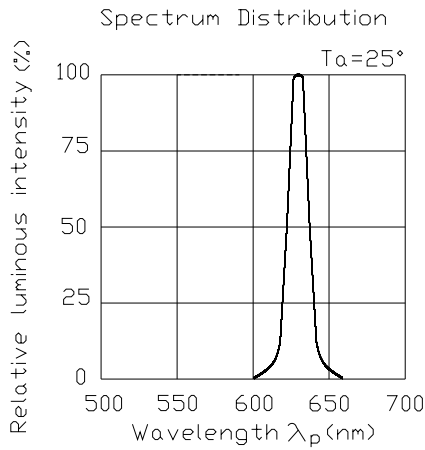
**Bin Range Of Forward Voltage**

Group	Bin	Min	Max	Unit	Condition
<b>B</b>	0	1.75	1.95	V	IF=20mA
	1	1.95	2.15		
	2	2.15	2.35		

**Notes:**

- 1.Tolerance of Luminous Intensity  $\pm 11\%$
- 2.Tolerance of Dominant Wavelength  $\pm 1\text{nm}$
- 3.Tolerance of Forward Voltage  $\pm 0.1\text{V}$

**Typical Electro-Optical Characteristics Curves**

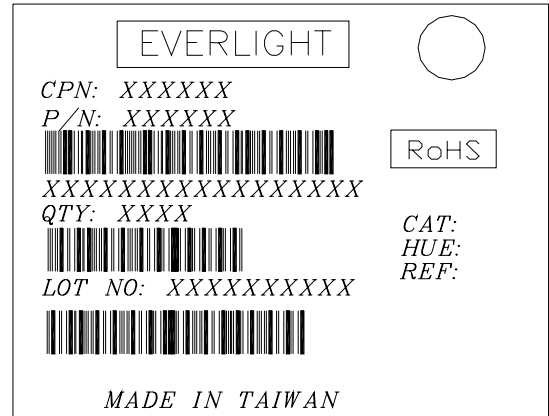


**Label explanation**

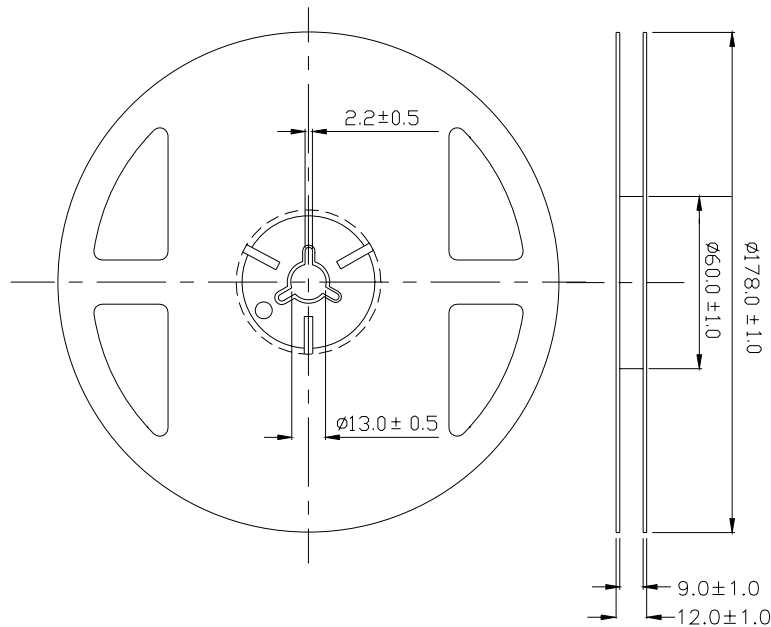
**CAT: Luminous Intensity Rank**

**HUE: Dom. Wavelength Rank**

**REF: Forward Voltage Rank**

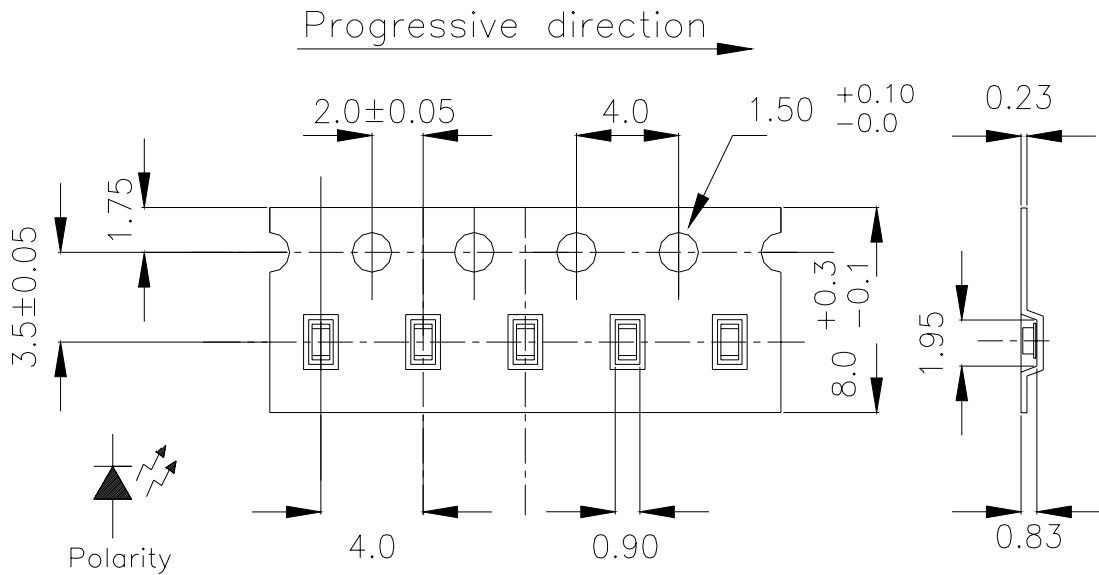


**Reel Dimensions**



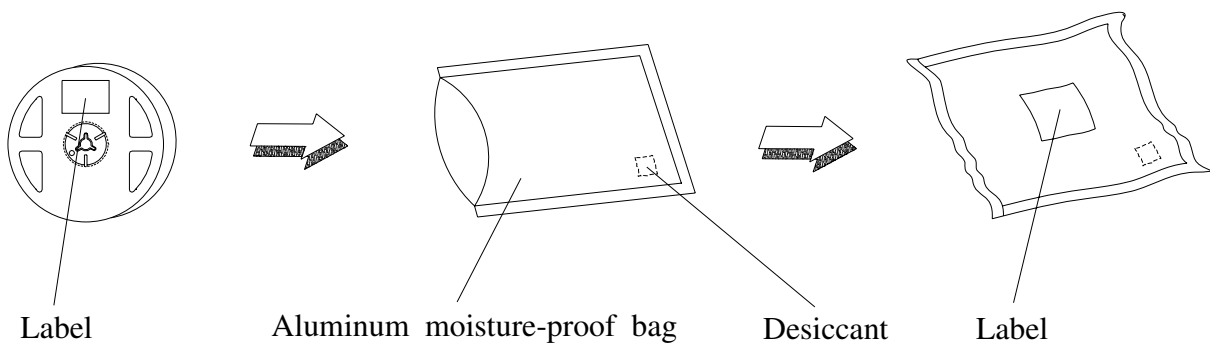
**Note:** The tolerances unless mentioned is  $\pm 0.1\text{mm}$  , Unit = mm

**Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel**



**Note:** The tolerances unless mentioned is  $\pm 0.1$  mm ,Unit = mm

**Moisture Resistant Packaging**





## Precautions For Use

### 1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change ( Burn out will happen ).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less.

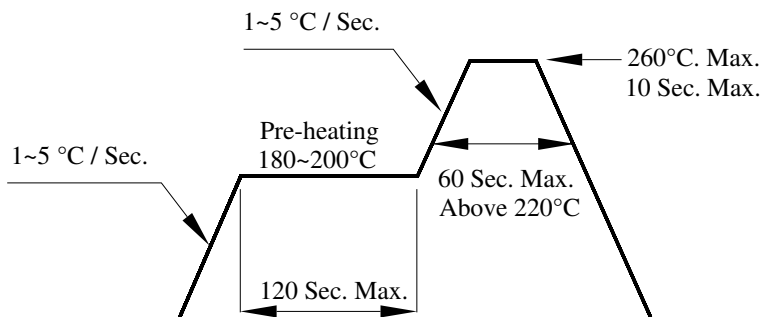
If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : 60±5°C for 24 hours.

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

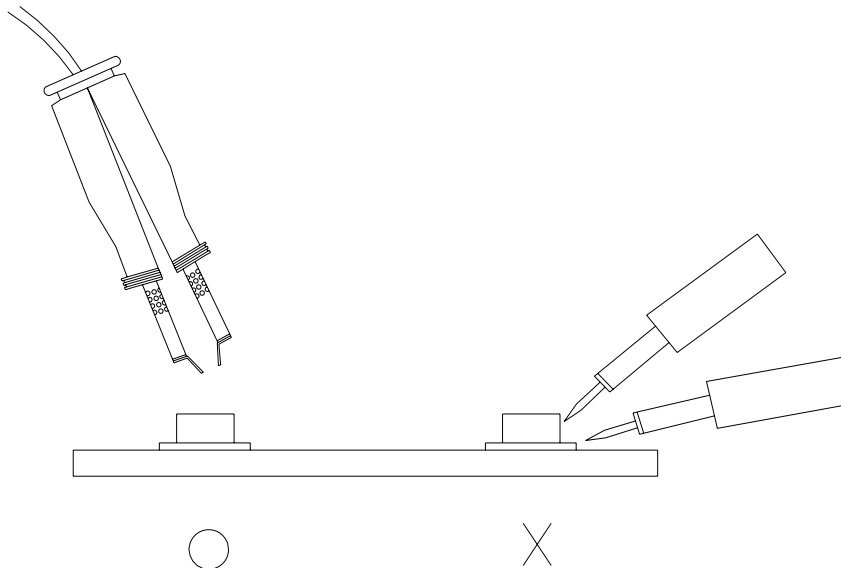
3.4 After soldering, do not warp the circuit board.

#### 4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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